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# FDPF5N50T

## N-Channel UniFET™ MOSFET

500 V, 5 A, 1.4 Ω

### Features

- $R_{DS(on)} = 1.15 \Omega$  (Typ.) @  $V_{GS} = 10 V, I_D = 2.5 A$
- Low Gate Charge (Typ. 11 nC)
- Low  $C_{rss}$  (Typ. 5 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

### Applications

- LCD/LED TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supplylications

### Description

UniFET™ MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



### Absolute Maximum Ratings $T_C = 25^\circ C$ unless otherwise noted.

Symbol	Parameter	FDPF5N50T	Unit
$V_{DSS}$	Drain to Source Voltage	500	V
$V_{GSS}$	Gate to Source Voltage	±30	V
$I_D$	Drain Current	- Continuous ( $T_C = 25^\circ C$ )	5*
		- Continuous ( $T_C = 100^\circ C$ )	3*
$I_{DM}$	Drain Current	- Pulsed (Note 1)	20*
$E_{AS}$	Single Pulsed Avalanche Energy	(Note 2)	225
$I_{AR}$	Avalanche Current	(Note 1)	5
$E_{AR}$	Repetitive Avalanche Energy	(Note 1)	8.5
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5
$P_D$	Power Dissipation	( $T_C = 25^\circ C$ )	28
		- Derate Above $25^\circ C$	0.22
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	°C
$T_L$	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	300	°C

\*Drain current limited by maximum junction temperature

### Thermal Characteristics

Symbol	Parameter	FDPF5N50T	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	4.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

## Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDPF5N50T	FDPF5N50T	TO-220F	Tube	N/A	N/A	50 units

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
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### Off Characteristics

$BV_{DSS}$	Drain to Source Breakdown Voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0 \text{V}, T_J = 25^\circ\text{C}$	500	-	-	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$	-	0.6	-	$V/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 50 \text{V}, V_{GS} = 0 \text{V}$	-	-	1	$\mu\text{A}$
		$V_{DS} = 400 \text{V}, T_C = 125^\circ\text{C}$	-	-	10	
$I_{GSS}$	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{V}, V_{DS} = 0 \text{V}$	-	-	$\pm 100$	nA

### On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$	3.0	-	5.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 10 \text{V}, I_D = 2.5 \text{A}$	-	1.15	1.4	$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 20 \text{V}, I_D = 2.5 \text{A}$	-	4.3	-	S

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = 25 \text{V}, V_{GS} = 0 \text{V}, f = 1 \text{MHz}$	-	480	640	pF
$C_{oss}$	Output Capacitance		-	66	88	pF
$C_{rss}$	Reverse Transfer Capacitance		-	5	8	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	$V_{DS} = 400 \text{V}, I_D = 5 \text{A}, V_{GS} = 10 \text{V}$	-	11	15	nC
$Q_{gs}$	Gate to Source Gate Charge		-	3	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge		(Note 4)	-	5	-

### Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 250 \text{V}, I_D = 5 \text{A}, V_{GS} = 10 \text{V}, R_G = 25 \Omega$	-	13	36	ns
$t_r$	Turn-On Rise Time		-	22	54	ns
$t_{d(off)}$	Turn-Off Delay Time		-	28	66	ns
$t_f$	Turn-Off Fall Time		(Note 4)	-	20	50

### Drain-Source Diode Characteristics

$I_S$	Maximum Continuous Drain to Source Diode Forward Current	-	-	5	A	
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	20	A	
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{V}, I_{SD} = 5 \text{A}$	-	-	1.4	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0 \text{V}, I_{SD} = 5 \text{A}, dI_F/dt = 100 \text{A}/\mu\text{s}$	-	300	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	1.8	-	$\mu\text{C}$

#### Notes:

- 1: Repetitive rating; pulse-width limited by maximum junction temperature.
- 2:  $L = 18 \text{mH}, I_{AS} = 5 \text{A}, V_{DD} = 50 \text{V}, R_G = 25 \Omega$ , starting  $T_J = 25^\circ\text{C}$ .
- 3:  $I_{SD} \leq 5 \text{A}, di/dt \leq 200 \text{A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , starting  $T_J = 25^\circ\text{C}$ .
- 4: Essentially independent of operating temperature typical characteristics.

## Typical Performance Characteristics

Figure 1. On-Region Characteristics

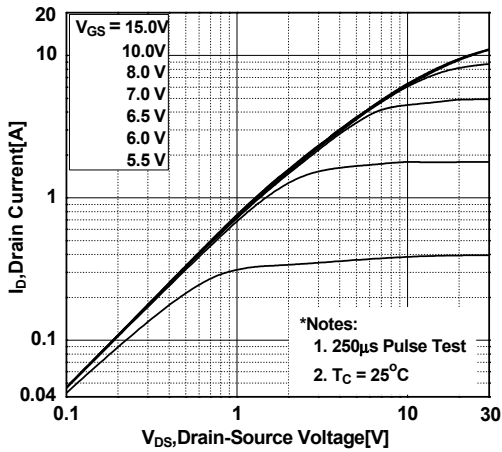


Figure 2. Transfer Characteristics

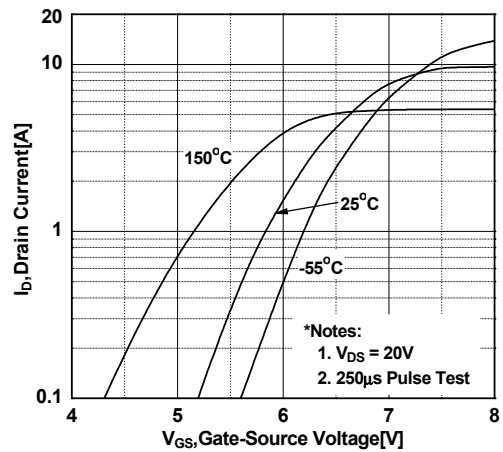


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

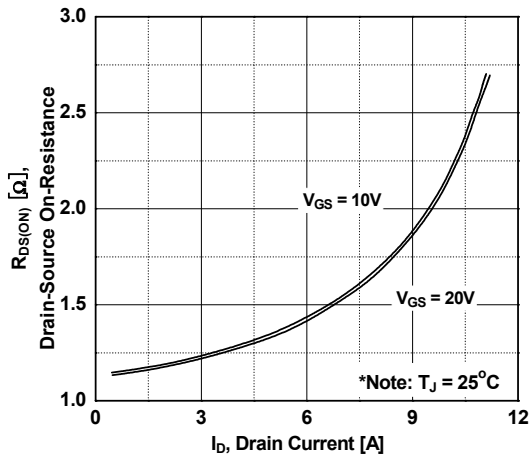


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

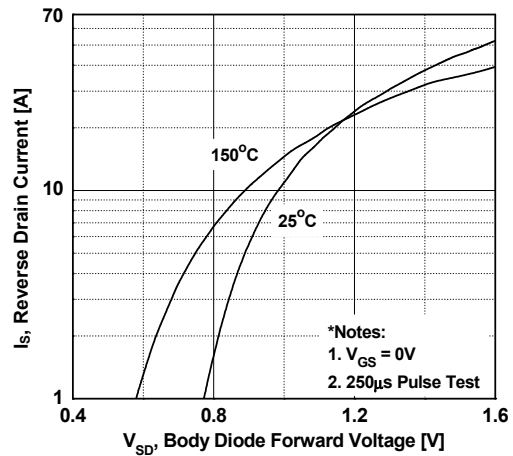


Figure 5. Capacitance Characteristics

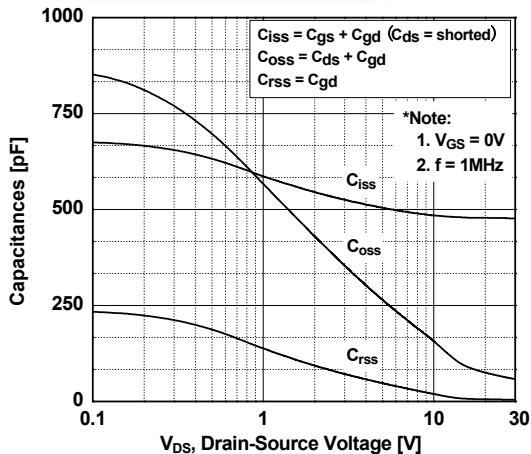
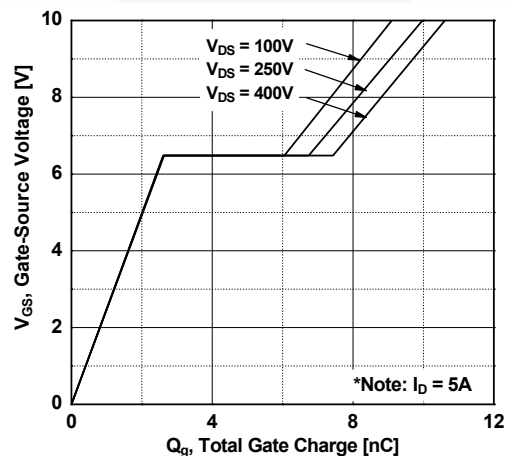
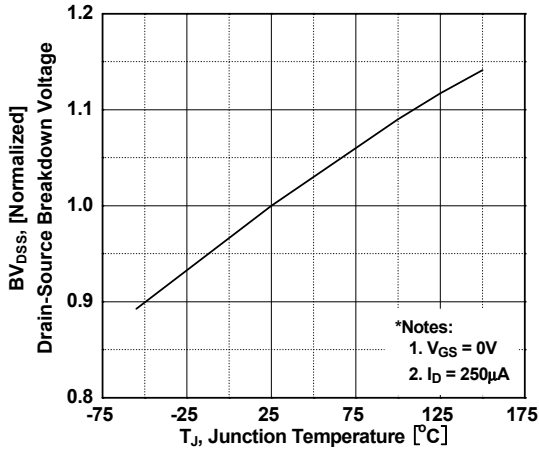


Figure 6. Gate Charge Characteristics

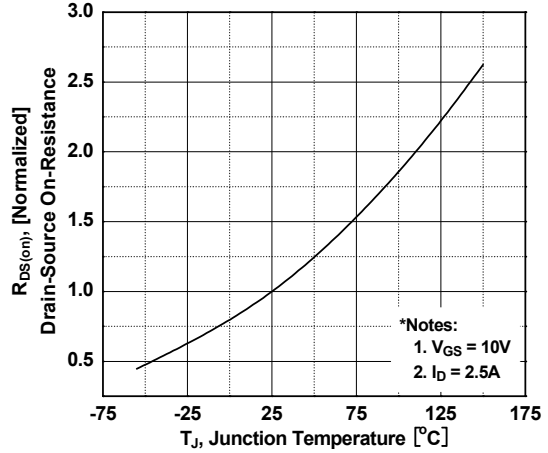


**Typical Performance Characteristics** (Continued)

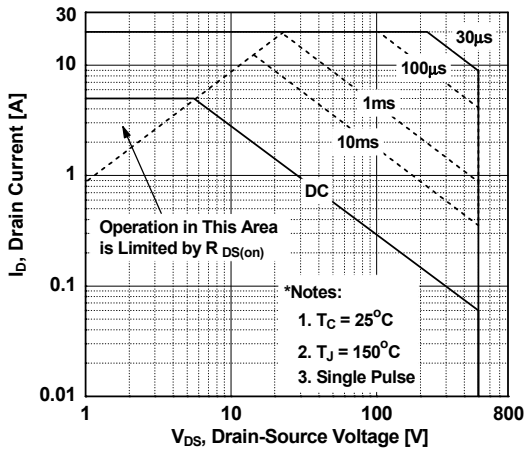
**Figure 7. Breakdown Voltage Variation vs. Temperature**



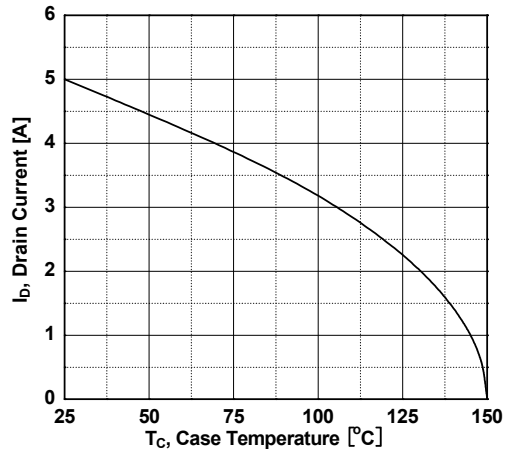
**Figure 8. On-Resistance Variation vs. Temperature**



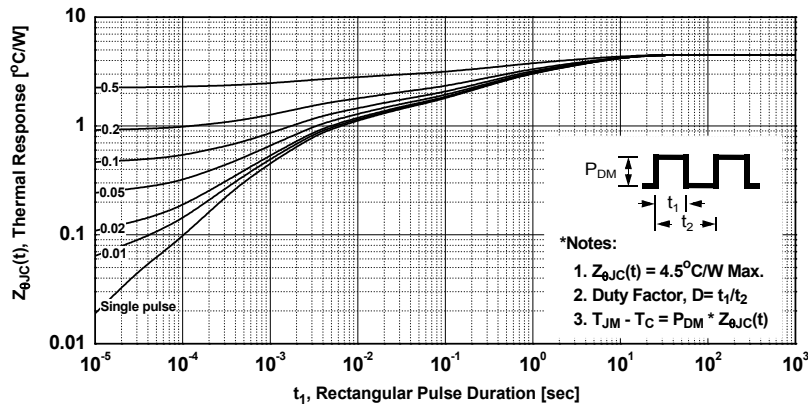
**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11. Transient Thermal Response Curve**





**Figure 12. Gate Charge Test Circuit & Waveform**



**Figure 13. Resistive Switching Test Circuit & Waveforms**



**Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms**



Figure 15. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms

## Mechanical Dimensions



**Figure 16. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead**

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